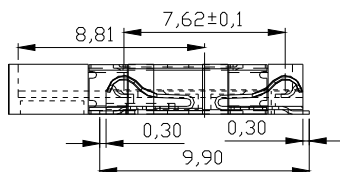
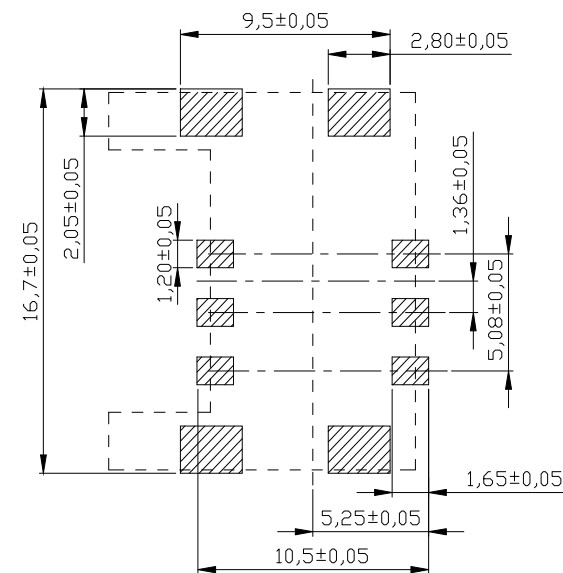
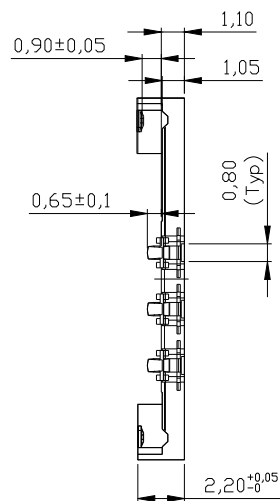
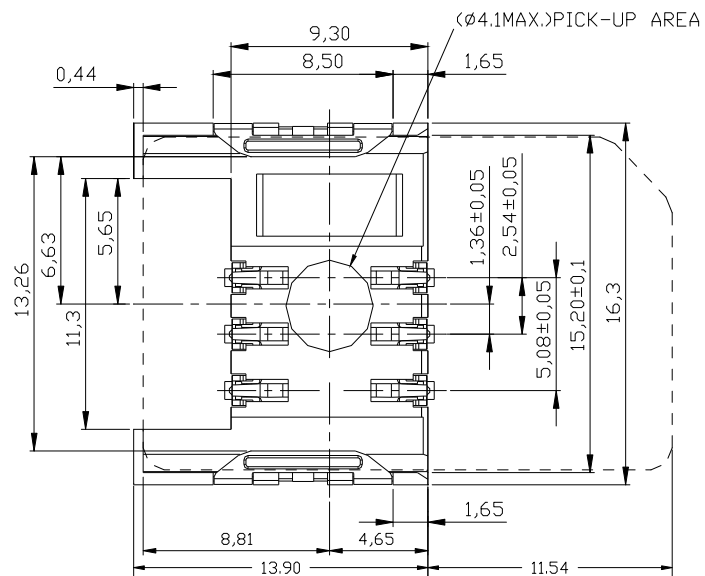


Mechanical Characteristics:

- Insulation material: LCP
- Solderability
- Wave: Not applicable
- Vapor phase: 215 °C, 30 sec. Max.
- IR reflow: 230 °C, 15 sec. Max.
- Manual soldering: 360 °C, 3 sec. Max.

Electrical Characteristics:

- Number of contacts: 6 pins
- Contact resistance: 50m OHM typical, 100m OHM max.
- Insulation resistance: > 1000 M OHM / 500 V DC



Unit:mm;Tolerances:±0.10mm
Reference Dimension for PCB layout

Промэлектроника
pr@promelec.ru



FILE NO.

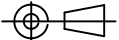
UNIT / mm

SCALE 1:1

CHECKED BY CY

DRAWING BY

PROJECTION



TOLERANCES ARE

.X ± 0.2

.XX ±

.XXX ±

AWG

DESCRIPTION:

SIM CARD CONNECTOR

AREA

REVISIONS

HK

DATE